



AI EDGE INFERENCE COMPUTER

RC0-6000-RPL-2-4B7M

AI Edge Inference Computer W/ LGA 1700 for Intel 12/13th Gen CPU & R680E PCH, 2x LAN, 6x SDD, 2x PCIe

Features

- LGA 1700 socket for 12/13th Gen. Intel® ADL & RPL Processor (35W TDP)
- Intel® R680E Chipset
- 2x DDR5 4800/5600MHz SODIMM. Max. up to 64GB
- Triple Independent Display: 2x DisplayPort, 1x DVI-I
- 2x Intel® 2.5 GbE supporting Wake-on-LAN and PXE
- 1x Full-size Mini PCIe for communication or expansion modules, 2x SIM socket
- 1x 9mm 2.5" SATA SSD (Internal), 1x 7mm 2.5" SATA SSD (Hot-swap)
- 4x 7mm Hot-swappable 2.5" SATA SSD Bay, Support RAID 0, 1, 5, 10
- 1x M.2 (E Key, PCIe x1, USB 2.0, 2230)
- 1x M.2 (B Key, 2242/3042/3052, PCIe x2, Support AI Module/NVMe Storage, PCIe x1 & USB 3.2 Gen1, Support 4G/5G)
- 6x RS-232/422/485 (4x internal), 8x USB 3.2 Gen 2, 1x USB 3.2 Gen 1 (internal)
- 8x DI + 8x DO with isolation
- 9 to 48VDC Wide Range Power Input Supporting AT/ATX Mode
- Wide Operating Temperature -25°C to 70°C (35W CPU)
- TPM 2.0 Supported
- EDGEBoost Options: 1x PCIe x16(Gen 4), 1x PCIe x1(Gen3) or 1x PCIe x16 (8-lane, Gen 4), 1x PCIe x8 (8-lane, Gen 4)



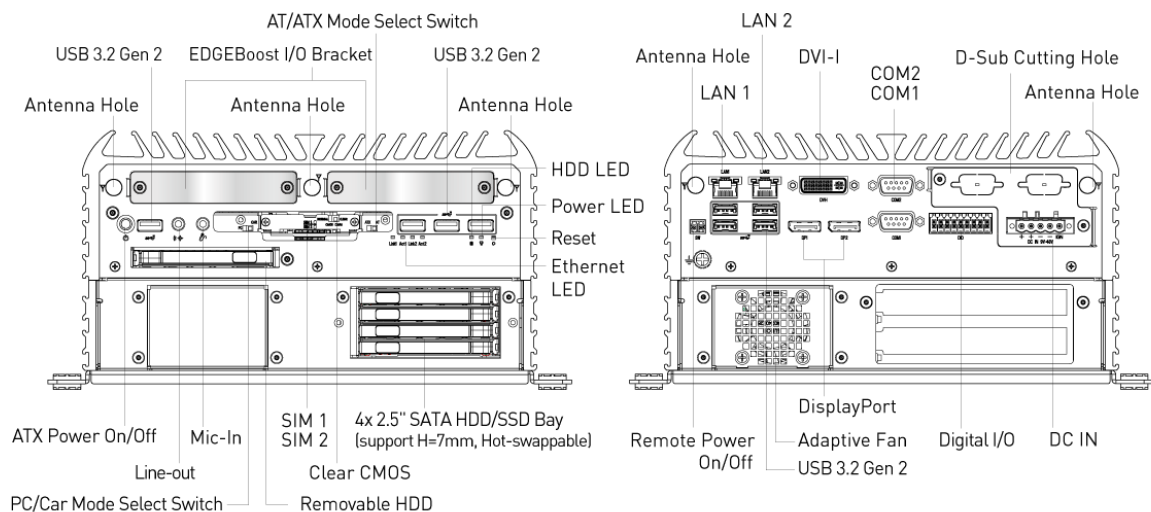
Specifications

System	
Processor	
Support 12/13th Gen Intel® ADL & RPL Processor (LGA 1700, 35W TDP)	
- Intel® Core™ i9-13900TE/i9-12900TE, up to 24 Cores, 36MB Cache, up to 5 GHz, 35W	
- Intel® Core™ i7-13700TE/i7-12700TE, up to 16 Cores, 30MB cache, up to 4.8 GHz, 35W	
- Intel® Core™ i5-13500TE/i5-12500TE, up to 14 Core, 24MB Cache, up to 4.5 GHz, 35W	
- Intel® Core™ i3-13100TE/i3-12100TE, up to 4 Cores, 12MB Cache, up to 4.1 GHz, 35W	
System Chipset	Intel® R680E Express Chipset
LAN Chipset	2.5 GbE1: Intel I226, 2.5 GbE2: Intel I226 Support Wake-on-LAN and PXE, Support TSN
Audio Codec	Realtek ALC888S
System Memory	2x 262-Pin DDR5 4800/5600MHz SODIMM. Max. up to 64GB (ECC and Non-ECC)
Graphics	Intel® UHD Graphics 770/710
BIOS	AMI 256Mbit SPI BIOS
Watchdog	Software Programmable Supports 1~255 sec. System Reset
AI Accelerator	Supports 3x Hailo-8™ modules
TPM	TPM 2.0
Display	
Display Port	2x DisplayPort 1.4a, Support resolution 5120 x 3200, Up to 7680 x 4320
DVI	1x DVI-I, support resolution 1920 x 1200
VGA	Yes (by optional split cable)
Multiple Display	Triple Display
Storage	
M.2	1x M.2 B Key, 2242/3042/3052 (PCIe x2, Support AI Module/NVMe Storage) (PCIe x1 & USB 3.2 Gen1, Support 4G/5G)
mSATA	1x mSATA (Shared by 1x Mini PCI Express)
SIM Socket	2x External SIM socket (Mini PCIe/M.2 B Key attached)
SSD/HDD	1x 9mm 2.5" SATA/SSD HDD Bay (Internal) 1x 7mm 2.5" SATA HDD/SSD Bay (Hot-swappable)
EDGEBoost Node Options:	
• SATA: 4x 7mm 2.5" SATA SSD Bay (Hot-swappable)	
Support RAID 0, 1, 5, 10	
Expansion	
M.2	1x M.2 (E Key, PCIe x1, USB 2.0, 2230)
Mini PCIe	1x Full-size Mini PCIe (1x shared by 1x mSATA)
PCIe	EDGEBoost Node Options: • 1x PCIe x16 (Gen 4), 1x PCIe x1 (Gen 3) • 1x PCIe x16 (8-lane, Gen 4), 1x PCIe x8 (8-lane, Gen 4)
Expansion Modules	
2x EDGEBoost I/O Brackets:	
• 4-port GbE module with Intel® I350 Chipset, RJ-45/M12 connector (PoE optional)	
• 2-Port RJ45 10GbE with Intel X710 Chipset	
• 4-Port USB 3.0 (share PCIe Gen2 x1 bandwidth)	
• 1x M.2 B-Key, 2242 for AI/NVMe, 1x M.2 B-Key, 3042/3052 for 5G/AI/NVMe	
• 1x M.2 M-Key, PCIe x4 Lane, 2242/2260 for AI Module/NVMe	
• 1x M.2 for 5G (B Key, PCIe x1, USB 3.0, 3042/3052), 2x SIM socket, 1x SIM switch	
Card Dimension	235 (L) x 112 (H) mm
I/O	
Audio	1x Mic-in, 1x Line-out
CAN	2x CAN 2.0 A/B 2-pin Internal header
COM	2x RS-232/422/485 ; 4x RS-232/422/485 (Internal)
DIO	8 in / 8 out (Isolated)
EDGEBoost I/O Bracket	2x EDGEBoost I/O Bracket (By mini PCIe interface)
LAN	2x RJ45

USB	8x USB 3.2 Gen 2 (10 Gbps) 1x USB 3.2 Gen 1 (5 Gbps, 1x Internal), 2x USB 2.0 (Internal)
Others	5x WiFi Antenna Holes 1x Power Switch, 1x AT/ATX Switch, 1x Remote Power On/Off 1x PC/Car Mode Switch, 1x Delay Time Switch 1x Removable CMOS Battery
Operating System	
Windows	Windows 10/11
Linux	Linux kernel
Power	
Power Adapter	Optional AC/DC 24V/9.2A, 220W Optional AC/DC 24V/15A, 360W (i7/i9 CPU)
Power Mode	AT, ATX
Power Ignition Sensing	Power Ignition Management
Power Supply Voltage	9~48VDC
Power Connector	5-pin Terminal Block
Power Protection	OVP (Over Voltage Protection) OCP (Over Current Protection) Reverse Protection
Environment	
Operating Temperature	-25°C to 70°C (35W CPU)
Storage Temperature	-30°C to 85°C
Relative Humidity	10% to 95% (non-condensing)
Certification	UL 62368 Ed. 3, CE, FCC Class A
Vibration	With HDD: 1 Grms (5 - 500 Hz, 0.5 hr/axis) With SSD: 5 Grms (5 - 500 Hz, 0.5 hr/axis)
Shock	With SSD: 50G half-sin 11ms
Physical	
Dimensions	240 (W) x 261 (D) x 126.8 (H) mm
Weights	6.5 ~ 7.5 kg
Construction	Extruded Aluminum with Heavy Duty Metal
Mounting Options	Wall Mounting

* All specifications and photos are subject to change without notice.

External I/O Mechanical Layout



Available EDGEBoost I/O



2x 5G SIM Slots



2x M.2 B-Key (1x 5G SIM)
(Right Universal Slot Only)



1x M.2 M-Key (4-Lane)



4x M12 LAN/POE Ports
(PoE: Left Universal Slot Only)



4x USB 3.0 Ports



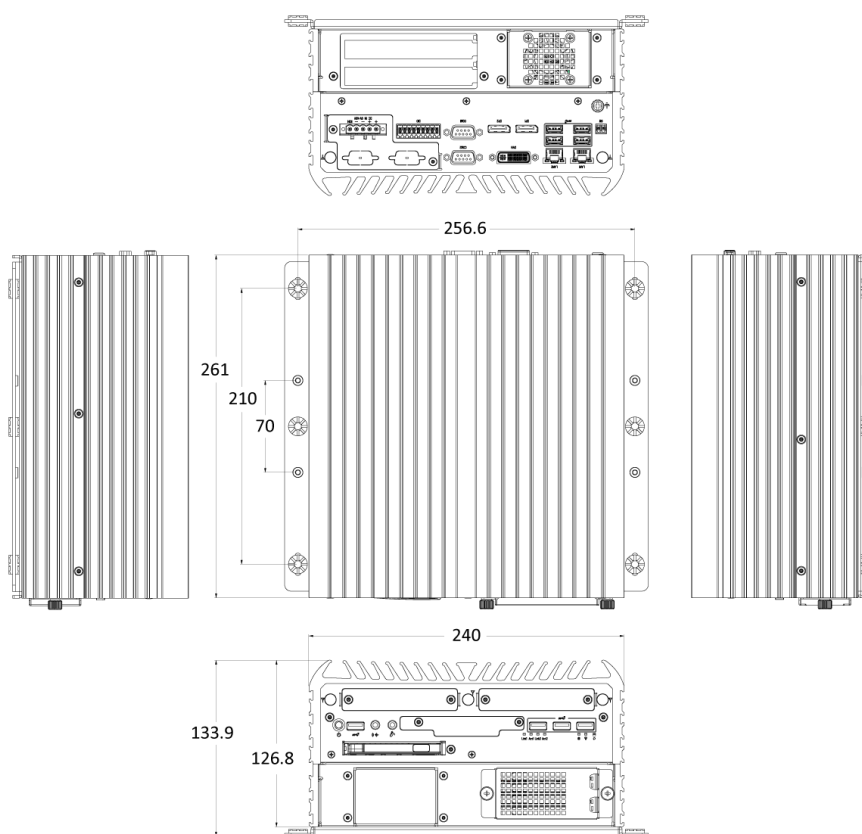
2x 10Gb Ports
(Right Universal Slot Only)



4x RJ45 LAN/POE Ports
(PoE: Left Universal Slot Only)

Dimension

Unit: mm



Available Models

Model No.	Description
RCO-6000-RPL-2E16-4B7M-P	Flash Storage Computing System w/ LGA 1700 for Intel® 12/13th Gen CPU & R680E PCH, 2x LAN, 1x PCIe x16 & x1, 4 Bay 7mm SATA
RCO-6000-RPL-2E8-4B7M-P	Flash Storage Computing System w/ LGA 1700 for Intel® 12/13th Gen CPU & R680E PCH, 2x LAN, 2x PCIe (8-lane), 4 Bay 7mm SATA

Optional Accessories

Model No.	Description
1-E09A22102	Adapter AC/DC 24V 9.2A 220W with 3pin Terminal Block Plug 5.0mm Pitch
1-E09A22801	Adapter AC/DC 24V/11.67A 280W with 3pin Terminal Block Plug 5.0mm Pitch
1-E09A36002	Adapter AC/DC 48V/7.5A 360W with 3pin Terminal Block Plug 5.0mm Pitch
999930	Power Cord, 3-pin US Type, 180cm
1-TPCD00002	Power Cord, European Type, 180cm
1-TPCD00001	Power Cord, 3-pin UK Type, 180cm

Packing List

1x RCO-6000-RPL Series Embedded System
 1x Wall Mount Kit
 1x Accessory Kit
 1x DVI to VGA Adapter

Compatible GPU AVL

Model	RAM	CUDA Cores	TDP	TOPS/TFLOPS	Displays	System Interface	Form Factor
NVIDIA T1000	8G	896	50W	5.3 TFLOPS	4x mDP	PCIe 3.0 x16	2.7" H x 6.1" L, Low-Profile Single Slot
NVIDIA RTX A1000	8G	2304	50W	6.74 TFLOPS	4x mDP	PCIe 4.0 x8	2.7" H x 6.4" L, Single slot
NVIDIA RTX A2000	12G	3328	70W	7.99 TFLOPS	4x mDP	PCIe 4.0 x16	2.7" H x 6.6" L, Low Profile, Dual Slot
NVIDIA RTX 2000 ADA	16G	2816	70W	12 TFLOPS	4x mDP	PCIe 4.0 x8	2.7" H x 6.6" L, Dual slot
NVIDIA RTX 4000 SFF ADA	20G	6144	70W	19.2 TFLOPS	4x mDP	PCIe 4.0 x16	2.7" H x 6.6" L, Low Profile, Dual Slot

Compliances and Standards

Vibration	With HDD: 1 Grms (5 - 500 Hz, 0.5 hr/axis) With SSD: 5 Grms (5 - 500 Hz, 0.5 hr/axis) IEC60068-2-64:2008 Designed to comply with MIL-STD-810G Method 514.7 Procedure I
Shock	With SSD: 50G half-sin 11ms IEC60068-2-27:2008 Designed to comply with MIL-STD-810G Method 516.7 Procedure I
Operating Temperature	-25°C to 70°C (35W CPU) IEC60068-2-1:2007 (Cold test procedure) IEC60068-2-2:2007 (Dry heat test procedure) IEC60068-2-3:2007 (Damp heat, steady state, test procedure) IEC60068-2-14:2009 (Wide temperature range thermal shock)
EMC	- FCC Class A - CE - ICES-003 - UKCA - Industrial EMC Compliance - EN 61000-4-2: 2009 - EN IEC 61000-4-3: 2020 - EN 61000-4-4: 2012 - EN 61000-4-5: 2014 +A1: 2017 - EN 61000-4-6: 2014
Safety	- UL Safety: UL62368-1, 3rd Ed., (cULus) - Test procedure: CB Scheme - Standard: IEC 62368-1:2018

Exports And Tariff Codes

ECCN	5A992.c
HTS	8471.50.0150
ScheduleB	84.71

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